Built-in antenna IEEE802.11b/g/n (1x1) Wireless LAN Module BP359B

HARDWARE SPECIFICATION

Version 1.0.0
## Revision history

<table>
<thead>
<tr>
<th>Ver.</th>
<th>Contents</th>
<th>Date</th>
</tr>
</thead>
<tbody>
<tr>
<td>1.0.0</td>
<td>First edition</td>
<td>17/4/17</td>
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</tbody>
</table>
1 ABSTRACT

This document is specification for the wireless LAN module built-in wireless LAN LSI BU1805GU and antenna based on IEEE802.11b/g/n (1×1) made by ROHM.
2 CONTENTS

1 ABSTRACT ................................................................. 3
2 CONTENTS ................................................................. 4
3 ABSOLUTE MAXIMUM RATINGS ....................................... 5
4 RECOMMENDED OPERATING CONDITIONS ....................... 6
5 MAIN CHARACTERISTICS ............................................... 7
6 BLOCK DIAGRAM .......................................................... 8
7 ELECTRICAL CHARACTERISTICS ..................................... 9
8 TERMINAL FUNCTIONS .................................................... 10
9 DIMENSIONS ............................................................... 12
10 PRECAUTIONS FOR MOUNTING ...................................... 13
11 ABOUT THE FIXATION OF THE MODULE ......................... 14
12 PRODUCT LABEL SPECIFICATION .................................... 15
13 REFERENCE CIRCUIT ..................................................... 16
14 PRECAUTIONS WHEN ACCESSING EEPROM .................... 20
15 PRECAUTIONS WHEN ACCESSING FLASH MEMORY OR ROM .... 21
16 OPERATING PRECAUTIONS ............................................. 23
17 PRECAUTIONS AS A WIRELESS EQUIPMENT .................... 24

PROPRIETARY AND CONFIDENTIAL
## 3  ABSOLUTE MAXIMUM RATINGS

<table>
<thead>
<tr>
<th>No.</th>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>LIMITS</th>
<th>UNIT</th>
<th>REMARKS</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Power supply voltage</td>
<td>VDD</td>
<td>-0.3 ~  +3.6</td>
<td>V</td>
<td>DC</td>
</tr>
<tr>
<td>2</td>
<td>Operating temperature range</td>
<td>Topr</td>
<td>-40 ~  +70</td>
<td>℃</td>
<td>No dew condensation</td>
</tr>
<tr>
<td>3</td>
<td>Storage temperature range</td>
<td>Tstg</td>
<td>-40 ~  +85</td>
<td>℃</td>
<td>No dew condensation</td>
</tr>
</tbody>
</table>

Note) Absolute maximum ratings are the values that must not be exceeded at any time under any application or any test conditions. Please make design keeping enough margins accordingly.
# 4 RECOMMENDED OPERATING CONDITIONS

<table>
<thead>
<tr>
<th>No.</th>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>SPEC</th>
<th>UNIT</th>
<th>REMARKS</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td><strong>MIN.</strong></td>
<td><strong>TYP.</strong></td>
<td><strong>MAX.</strong></td>
</tr>
<tr>
<td>1</td>
<td>Power supply voltage</td>
<td>VDD</td>
<td>3.1</td>
<td>3.3</td>
<td>3.5</td>
</tr>
<tr>
<td>2</td>
<td>Operating temperature range</td>
<td>Ta</td>
<td>-40</td>
<td>25</td>
<td>85</td>
</tr>
</tbody>
</table>
## 5 MAIN CHARACTERISTICS

<table>
<thead>
<tr>
<th>No.</th>
<th>PARAMETER</th>
<th>CHARACTERISTICS</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Frequency width</td>
<td>2,400MHz ~ 2,483.5 MHz (ch1 ~ ch13)</td>
</tr>
<tr>
<td>2</td>
<td>Frequency tolerance</td>
<td>Within ±25ppm</td>
</tr>
<tr>
<td>3</td>
<td>RF output power (*1)</td>
<td>IEEE802.11b: 15dBm±2dB&lt;br&gt;IEEE802.11g: 13dBm±2dB&lt;br&gt;IEEE802.11n: 12dBm±2dB</td>
</tr>
<tr>
<td>4</td>
<td>Supported data rates</td>
<td>IEEE802.11b: 1 ~ 11Mbps&lt;br&gt;IEEE802.11g: 6 ~ 54Mbps&lt;br&gt;IEEE802.11n: 6.5 ~ 72.2Mbps</td>
</tr>
<tr>
<td>5</td>
<td>Receiving sensitivity (*1)</td>
<td>IEEE802.11b: -94dBm @1Mbps, -89dBm @11Mbps&lt;br&gt;IEEE802.11g: -92dBm @6Mbps, -73dBm @54Mbps&lt;br&gt;IEEE802.11n: -90dBm @6.5Mbps, -68dBm @72.2Mbps</td>
</tr>
<tr>
<td>6</td>
<td>Security function</td>
<td>64bit/128bit WEP, TKIP, AES (*2)</td>
</tr>
<tr>
<td>7</td>
<td>Host Interface</td>
<td>USB2.0 (Full-Speed mode)&lt;br&gt;SPI&lt;br&gt;UART (~921600bps)</td>
</tr>
<tr>
<td>8</td>
<td>Power supply voltage</td>
<td>Only 3.3V</td>
</tr>
</tbody>
</table>

(*1) RF output power and Receiving sensitivity are the performance values at the electric feeding point of antenna shown in the figure below.

(*2) 64bit/128bit WEP, TKIP, and AES are everything processed with hardware.
6 BLOCK DIAGRAM

![Block Diagram]

- Between BP3580 and chip antenna, a switch type coaxial connector (MS-156C made by Hirose electric Co., Ltd.) is inserted. Please connect an external antenna to this connector if it is necessary.
  When using an external antenna, the built-in antenna (chip antenna) is disabled.
# 7 ELECTRICAL CHARACTERISTICS

**CONDITIONS** : Ta=25°C, VCC=3.3V, GND=0.0V

<table>
<thead>
<tr>
<th>No.</th>
<th>PARAMETER</th>
<th>CONDITION</th>
<th>MIN.</th>
<th>TYP.</th>
<th>MAX.</th>
<th>UNIT</th>
<th>REMARKS</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Consumption current</td>
<td>Sending</td>
<td>270</td>
<td>350</td>
<td>430</td>
<td>mA</td>
<td>Continuous</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Receiving</td>
<td>190</td>
<td>230</td>
<td>270</td>
<td>mA</td>
<td>-</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Sleep mode</td>
<td>-</td>
<td>1200</td>
<td>-</td>
<td>µA</td>
<td>Deep Sleep</td>
</tr>
<tr>
<td>2</td>
<td>Center frequency</td>
<td>-</td>
<td>2412</td>
<td>-</td>
<td>2472</td>
<td>MHz</td>
<td>-</td>
</tr>
<tr>
<td>3</td>
<td>Frequency deviation</td>
<td>-</td>
<td>-25</td>
<td>-</td>
<td>25</td>
<td>ppm</td>
<td>-</td>
</tr>
<tr>
<td>4</td>
<td>RF output power</td>
<td>11b : 11Mbps</td>
<td>13</td>
<td>15</td>
<td>17</td>
<td>dBm</td>
<td>(*1)</td>
</tr>
<tr>
<td></td>
<td></td>
<td>11g : 54Mbps</td>
<td>11</td>
<td>13</td>
<td>15</td>
<td>dBm</td>
<td>(*1)</td>
</tr>
<tr>
<td></td>
<td></td>
<td>11n : MCS7</td>
<td>10</td>
<td>12</td>
<td>14</td>
<td>dBm</td>
<td>(*1)</td>
</tr>
<tr>
<td>5</td>
<td>Unnecessary emission in the out-of-band</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>2.5</td>
<td>µW/MHz</td>
<td>-</td>
</tr>
<tr>
<td>6</td>
<td>Transmit spectrum mask</td>
<td>DSSS</td>
<td>-</td>
<td>-</td>
<td>-30</td>
<td>dBr</td>
<td>1(^{st}) Side-lobe</td>
</tr>
<tr>
<td></td>
<td></td>
<td>11Mbps</td>
<td>-</td>
<td>-</td>
<td>-50</td>
<td>dBr</td>
<td>2(^{nd}) Side-lobe</td>
</tr>
<tr>
<td></td>
<td></td>
<td>OFDM</td>
<td>-</td>
<td>-</td>
<td>-20</td>
<td>dBr</td>
<td>±11MHz</td>
</tr>
<tr>
<td></td>
<td></td>
<td>54Mbps</td>
<td>-</td>
<td>-</td>
<td>-28</td>
<td>dBr</td>
<td>±20MHz</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>-</td>
<td>-</td>
<td>-40</td>
<td>dBr</td>
<td>±30MHz</td>
</tr>
<tr>
<td>7</td>
<td>Receiving sensitivity</td>
<td>11b : 11Mbps</td>
<td>-</td>
<td>-89</td>
<td>-76</td>
<td>dBm</td>
<td>PER&lt;8% (*1)</td>
</tr>
<tr>
<td></td>
<td></td>
<td>11g : 54Mbps</td>
<td>-</td>
<td>-73</td>
<td>-65</td>
<td>dBm</td>
<td>PER&lt;10% (*1)</td>
</tr>
<tr>
<td></td>
<td></td>
<td>11n : MCS7</td>
<td>-</td>
<td>-68</td>
<td>-64</td>
<td>dBm</td>
<td>PER&lt;10% (*1)</td>
</tr>
<tr>
<td>8</td>
<td>RX spurious</td>
<td>Fr&lt;1GHz</td>
<td>-</td>
<td>-</td>
<td>4</td>
<td>nW</td>
<td>-</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Fr≥1GHz</td>
<td>-</td>
<td>-</td>
<td>20</td>
<td>nW</td>
<td>-</td>
</tr>
</tbody>
</table>

(*1) At electric feeding point of antenna
8 TERMINAL FUNCTIONS

Back Side

BP359B Connector (Socket) Type
: AXK5F34347YG (Panasonic Electric Works Co., Ltd.)

User-side Connector (header) Type
: AXK6F34347YG(Panasonic Electric Works Co., Ltd.)

Table 1. Module Terminal Functions (1/2)

<table>
<thead>
<tr>
<th>No.</th>
<th>Terminal</th>
<th>I/O</th>
<th>Function</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>UART_RTS</td>
<td>O</td>
<td>UART Flow Control</td>
<td>-</td>
</tr>
<tr>
<td>2</td>
<td>UART_CTS</td>
<td>I</td>
<td>UART Flow Control</td>
<td>-</td>
</tr>
<tr>
<td>3</td>
<td>GND</td>
<td>-</td>
<td>Ground</td>
<td>-</td>
</tr>
<tr>
<td>4</td>
<td>GND</td>
<td>-</td>
<td>Ground</td>
<td>-</td>
</tr>
<tr>
<td>5</td>
<td>USB_DM</td>
<td>AI/O</td>
<td>USB Data Minus</td>
<td>-</td>
</tr>
<tr>
<td>6</td>
<td>USB_DP</td>
<td>AI/O</td>
<td>USB Data Plus</td>
<td>-</td>
</tr>
<tr>
<td>7</td>
<td>SPI_CLK</td>
<td>O/I</td>
<td>SPI Data Clock</td>
<td>Master: O / Slave: I</td>
</tr>
<tr>
<td>8</td>
<td>VDD</td>
<td>-</td>
<td>Power Supply 3.3V</td>
<td>-</td>
</tr>
<tr>
<td>9</td>
<td>VDD</td>
<td>-</td>
<td>Power Supply 3.3V</td>
<td>-</td>
</tr>
<tr>
<td>10</td>
<td>SPI_TXD</td>
<td>O</td>
<td>SPI Transmit Data</td>
<td>-</td>
</tr>
<tr>
<td>11</td>
<td>SPI_RXD</td>
<td>I</td>
<td>SPI Receive Data</td>
<td>-</td>
</tr>
<tr>
<td>12</td>
<td>SPI_RDY</td>
<td>I/O</td>
<td>SPI Ready</td>
<td>Master: I / Slave: O</td>
</tr>
<tr>
<td>13</td>
<td>UART_RXD</td>
<td>I</td>
<td>UART Receive Data</td>
<td></td>
</tr>
<tr>
<td>14</td>
<td>UART_TXD</td>
<td>O</td>
<td>UART Transmit Data</td>
<td></td>
</tr>
<tr>
<td>15</td>
<td>BOOT_SEL1</td>
<td>I</td>
<td>Boot Mode Select</td>
<td>BOOT_SEL [1:0]</td>
</tr>
<tr>
<td>16</td>
<td>BOOT_SEL0</td>
<td>I</td>
<td>Boot Mode Select</td>
<td>00:USB, 01:SPI, 10:Reserve, 11:USB</td>
</tr>
<tr>
<td>17</td>
<td>SPI_FS</td>
<td>O/I</td>
<td>SPI Device Select</td>
<td>Master: O / Slave: I</td>
</tr>
</tbody>
</table>
Table 1. Module Terminal Functions (2/2)

<table>
<thead>
<tr>
<th>No.</th>
<th>Terminal</th>
<th>I/O</th>
<th>Function</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>18</td>
<td>GPIO10</td>
<td>I/O</td>
<td>General Purpose Input / Output 10</td>
<td>Factory Default Firmware Boot</td>
</tr>
<tr>
<td>19</td>
<td>GPIO11</td>
<td>I/O</td>
<td>General Purpose Input / Output 11</td>
<td>Cable LAN/Wireless LAN Switch</td>
</tr>
<tr>
<td>20</td>
<td>GPIO12</td>
<td>I/O</td>
<td>General Purpose Input / Output 12</td>
<td>Combination with SPI_HOST INT</td>
</tr>
<tr>
<td>21</td>
<td>GPIO13</td>
<td>O/I</td>
<td>General Purpose Input / Output 13</td>
<td>Combination with SPI_WAKE UP</td>
</tr>
<tr>
<td>22</td>
<td>FLASH_SEL</td>
<td>I</td>
<td>Flash Boot Area Select</td>
<td>0: Region1, 1: Region2</td>
</tr>
<tr>
<td>23</td>
<td>GPIO00</td>
<td>I</td>
<td>General Purpose Input / Output 0</td>
<td>INITIALIZE</td>
</tr>
<tr>
<td>24</td>
<td>GPIO01</td>
<td>I</td>
<td>General Purpose Input / Output 1</td>
<td>WPS</td>
</tr>
<tr>
<td>25</td>
<td>M_ANA</td>
<td>AI</td>
<td>Analog Monitor</td>
<td>Reserve</td>
</tr>
<tr>
<td>26</td>
<td>GPIO2</td>
<td>O</td>
<td>General Purpose Input / Output 2</td>
<td>Status LED</td>
</tr>
<tr>
<td>27</td>
<td>GPIO14</td>
<td>O</td>
<td>General Purpose Input / Output 14</td>
<td>Wake On LAN</td>
</tr>
<tr>
<td>28</td>
<td>SRST</td>
<td>I</td>
<td>Soft Reset</td>
<td>0: Reset, 1: Normal</td>
</tr>
<tr>
<td>29</td>
<td>PRST</td>
<td>I</td>
<td>Power On Reset</td>
<td>0: Reset, 1: Normal</td>
</tr>
<tr>
<td>30</td>
<td>TMS</td>
<td>I</td>
<td>ARM JTAG TDO</td>
<td>For Debug</td>
</tr>
<tr>
<td>31</td>
<td>TCK</td>
<td>I</td>
<td>ARM JTAG TCK</td>
<td>For Debug</td>
</tr>
<tr>
<td>32</td>
<td>TDI</td>
<td>I</td>
<td>ARM JTAG TDI</td>
<td>For Debug</td>
</tr>
<tr>
<td>33</td>
<td>TDO</td>
<td>O</td>
<td>ARM JTAG TDO</td>
<td>For Debug</td>
</tr>
<tr>
<td>34</td>
<td>TRSTB</td>
<td>I</td>
<td>ARM JTAG TRSTB</td>
<td>For Debug</td>
</tr>
</tbody>
</table>

The PRST terminal is connected to the 32bit MCU reset terminal inside the module.
The SRST terminal is connected to the 32bit MCU GPIO terminal inside the module.
Reset processing using SRST will only be reset to BP3580.
ARM JTAG terminal is connected to the 32bit MCU ARM debug terminal inside the module.
BOOT_SEL1 and BOOT_SEL0 are pulled down inside the module. To make the logic of these
PINs “Low”, please make pin processing “OPEN”.
Unused terminals are pinned “Lo” or “Hi” inside the module, so please “OPEN” it.
9 DIMENSIONS

Fig.2  Dimensions (Unit: mm)
10 PRECAUTIONS FOR MOUNTING

(1) Don’t draw GND solid pattern and wiring on the area overlapping the Prohibited area on the customer’s board.

(2) Please do not place parts in 1cm around the Prohibited area. Also, keep the case away from the case (chassis) away from the Prohibited area by 1cm or more.

(3) Material of the case (chassis) should be nonmetal.

(4) Please do not place parts other than specified connector and spacer under BP359B.
11 ABOUT THE FIXATION OF THE MODULE

For fixing BP359B, please use metal M2 screw. Please sandwich the metal spacer with a height of 1.5mm between BP359B and the customer board, and secure with a M2 screw and a nut.

The holes for fixing with M2 screw are the same potential as GND of BP359B. Please connect with GND of BP359B and GND of customer board with metal spacer.

Make sure that the torque when tightening the M2 screw is 1kgf·cm or more and be careful not to over tighten it.

![Fig.4 Fixed Module Figure (Side view)]
12 PRODUCT LABEL SPECIFICATION

The label shown in the following figure is put on the shield case of BP359B.

![Product Label Spec](image)

*Micro QR code has information on the MAC address.
(Note) The design of product label might change without previous notice.
13 REFERENCE CIRCUIT

13-1 USB HOST INTERFACE

*About USB_DP and USB_DM Lines

- Please shorten the wiring length as much as possible.
- Please take the differential impedance matching to 90Ω±10%.
- Please set up to 45Ω±10% for impedance matching of single end.
- Please wire USB_DP and USB_DM lines same lengths as possible.
- Please design so that the wiring length difference is 0.5mm or less.
- Please do not bend USB lines many times and make the bending angle wide angle.
- Please do not make throw hole in wiring if possible.
- Please do not cross the USB lines and another signal lines.
- Please do not cross the USB lines and a power supply line.

*Please reduce the ripple of power supply (VCC=3.3V) as much as possible. (less than 10mVpp)
13-2 SPI HOST INTERFACE

Fig. 7 SPI Host Interface Reference Circuit

*Please reduce the ripple of power supply (VCC=3.3V) as much as possible. (less than 10mVpp)
13-3 UART HOST INTERFACE

*Please reduce the ripple of power supply (VCC=3.3V) as much as possible. (less than 10mVpp)
13-4 Reset IC

Fig.9  Reset IC Connection Reference Circuit
14 PRECAUTIONS WHEN ACCESSING EEPROM

・Please do not reset (PRST, SRST, COMMAND RESET) when BP359B is accessing internal EEPROM.
・If reset is performed during EEPROM loading, reset may not be performed normally, and it may not be recovered unless power is restored again.

The data will be loaded from EEPROM at the following timing.

①After resetting.
Immediately after power-on or after resetting, the data will be loaded from EEPROM within 100ms.

②When transition to communication mode.
The data will be loaded from EEPROM between transition to communication mode and reception of “device-ready signal”.

③When WID_SERIAL_NUMBER command is issued.
The data will be loaded from EEPROM between issuing WID_SERIAL_NUMBER (Message type “Q”) and receiving WID_STATUS.
15 PRECAUTIONS WHEN ACCESSING FLASH MEMORY OR ROM

• When BP359B is accessing the internal flash memory or the ROM built-in 32bit MCU, please do not reset(PRST, SRST or Command reset) or turn off the power.
• When BP359B is implemented reset or turn off the power while writing(*) to the flash memory or the ROM, the writing may be interrupted and BP359B may not operate correctly.
• In General, flash memory has limitations on the number of write operations. Please design to minimize the number of writes to flash memory.

(*)About write operation to flash memory or ROM
Writing to the flash memory or ROM is performed at the following timing.

1) When updating firmware, root certificate or certification revocation list (CRL).
   The flash memory/ROM is being written during the period from issuing WID_HTTP_UPDATE_FW, WID_HTTP_UPDATE_CERT or WID_HTTP_UPDATE_CRL of message type ‘W’ until WID_STATUS response is returned.

2) On startup immediately after firmware update.
   After successfully issuing the WID command (WID_HTTP_UPDATE_FW, WID_HTTP_UPDATE_CERT or WID_HTTP_UPDATE_CRL) of message type ‘W’, writing to the flash memory/ROM is performed until ‘+’ is received at the next startup.

3) When returning to factory default firmware.
   After booting with GPIO10 set to ‘Hi’, writing to the flash memory/ROM is performed until ‘+’ is received.

4) When WPS is run in standalone mode and credentials are written.
   After run WPS in standalone mode, and writing to the flash memory/ROM is performed for 10 seconds after successful connection.
   In the case of executing WPS by the WID command, after receiving the WID_STATUS (value=0x01) response after issuing WID_WPS_START (value=0x01/0x02) of the message type ‘W’, writing to the flash memory/ROM is performed for 10 seconds after receipt of notification of connection completion by WID_STATUS (value=0x01) of message type ‘I’.
When starting WPS running GPIO01 with ‘Hi’, writing to the flash memory/ROM is done for 10 seconds after receiving the connection completion notification with the WID_STATUS (value=0x01) of message type ‘I’.

5) When deleting credential information.
After issuing WID_WPS_START (value=0x03) of message type ‘W’, writing to the flash memory/ROM is performed until the WID_STATUS response is received.
In addition, writing to the flash memory/ROM is performed until ‘+’ is received after booting with GPIO0 set to “Hi”.

6) When setting check-ID on firmware or root certificate.
Writing to the flash memory/ROM is performed from issuing WID_CHKID_FW or WID_CHKID_CERT of message type ‘W’ until receiving WID_STATUS.

7) When entering IPL command input mode.
When ‘+’ is being received, writing to the flash memory/ROM is performed until the space key (0x20) is input 8 times and ‘#’ is received.

8) When performing firmware update in IPL command input mode.
After issuing the ‘fwload’ command, writing to the flash memory/ROM is performed until firmware is sent via UART and ‘OK’ is received.
16 OPERATING PRECAUTIONS

1) Within one packing, the MAC address of the product may not be sequential number.
2) Claims on the presence or absence of fillets of parts mounted on BP359B are not accepted.
3) The label claim affixed to BP359B is not accepted except “peeling”, “protrusion” and “extreme character recognition failure”.
4) The connector may come off if it receives excessive vibration or impact. When using it where there is a risk of receiving vibration or shock, please give full evaluation in advance.
5) The connector of BP359B is not a specification assuming multiple insertion and removal. Please set the number of times of insertion / removal with 10 times.
6) If the external antenna is used for a long time, the elastic force of the spring inside the coaxial connector weakens and the built-in antenna (chip antenna) may become unusable. Please do not use external antenna together with built-in antenna.
17 PRECAUTIONS AS A WIRELESS EQUIPMENT

BP359B acquired “Certification of Construction Type” (Article 38-24, Clause1 of Radio Law in Japan) of “Particular wireless equipment: Low power data communications system in the 2.4GHz band, which is a Wireless equipment in Article 2-1(19)”

Therefore, only in Japan, it is possible to use as wireless equipment without certification of Japanese radio law.

*Certification of construction type number : 003-150031

Be sure to keep following notes to use the module safely as wireless equipment.

1) The laser marking on the shield case indicates certification number and certification marking of Japanese radio law. Please do not conceal the laser marking.

2) Please do not resolve or remodel strictly because there are some cases of receiving penalty based on Japanese radio law.

3) Please use the certificated antenna(*).

(*) Please contact us about the certificated antenna separately.
**Precautions for Safety**

1) Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronics appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment, transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property (“Special Applications”), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM’s Products for Specific Applications.

2) ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures.

   [a] Installation of protection circuits or other protective devices to improve system safety
   [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

3) Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM’s Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:

   [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
   [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
   [c] Use of our Products in places where the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
   [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
[e] Use in environment subject to strong vibration and impact.

[f] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items

[g] Sealing or coating our Products with resin or other coating materials

[h] Use of the Products in places subject to dew condensation

4) The products might receive the radio wave interference from electronic devices such as Wireless LAN devices, Bluetooth® devices, digital cordless telephone, microwave oven and so on that radiate electromagnetic wave.

5) The Products are not subject to radiation-proof design.

6) Please verify and confirm characteristics of the final or mounted products in using the Products.

7) Confirm that operation temperature is within the specified range described in the product specification.

8) ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

9) This product is a specification to radiate the radio wave. It is necessary to acquire the attestation of decided Radio Law of each region used to use the equipment that radiates the radio wave. Please inquire about the attestation of Radio Law that this product acquires.

10) When product safety related problems arises, please immediately inform to ROHM, and consider technical counter measure.

● Precautions Regarding Reference Circuit

1) If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.

2) You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise you own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for damages, expenses or losses
incurred by you or third parties arising from the use of such information.

● **Precaution for Electrostatic**
This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

● **Precaution for Storage / Transportation**
1) Product performance and soldered connections may deteriorate if the Products are stored in the places where:
   [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
   [b] the temperature or humidity exceeds those recommended by ROHM
      Temperature : 5°C-40°C, Humidity : 40%-60%
   [c] the Products are exposed to direct sunshine or condensation
   [d] the Products are exposed to high Electrostatic

2) The performance of connector fitting is guaranteed for one year from the time of shipment from ROHM only when the above storage conditions are observed.

3) Store / transport cartons in the correct direction, which is indicated on a carton as a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.

● **Precaution for product label**
QR code printed on ROHM product package label is for ROHM’s internal use only, and please do not use at customer site.

● **Precaution for disposition**
When disposing Products, please dispose them properly using an authorized industry waste company.

● **Precaution Regarding Intellectual Property Rights**
1) All information and data including but not limited to application example contained in this document is for reference only. ROHM does not warrant that foregoing information or data will
not infringe any intellectual property rights or any other rights of any third party regarding such information or data.

2) ROHM shall not have any obligations where the claims, actions or demands arising from the combination of the Products with other articles such as components, circuits, systems or external equipment (including software)

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